I2C Bus Transceiver

JLC1563 is an I2C-bus signal transceiver and "conditioner". Currently, systems complexity and I2C-bus device types and functionality are only increasing. As a result of I2C-bus loading the Clock line and Data line signals degrade. The JLC1563 I2C-Bus Transceiver restores clean signals in the system leading to improvements in system performance and reliability.

This device has two pins, SCL1 (Serial Clock Input) and SDA1 (Serial Data I/O), on the Master I2C–bus side; and two pins, SCL2 (Serial Clock Output) and SDA2 (Serial Data I/O), on the Slave I2C–bus side.

Two reset pins, Reset1 and Reset2, drive separate internal comparators and a system Power–On–Reset function is supported.

Features

- Low Power Dissipation
- Two Pin Reset/Power–On–Reset
- Waveform Cleaning



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HIGH-PERFORMANCE CMOS

LOW-POWER COMPLEMENTARY MOS SILICON-GATE



A = Assembly Location WL, L = Wafer Lot YY, Y = Year WW, W = Work Week

ORDERING INFORMATION

Device	Package	Shipping
JLC1563P	PDIP-8	50 Units/Rail
JLC1563M	SOEIAJ-8	See Note 1.
JLC1563ML1	SOEIAJ-8	See Note 1.

1. For ordering information on the EIAJ version of the SOIC packages, please contact your local ON Semiconductor representative.

PIN CONNECTIONS



PIN LIST				
SCL 1	MASTER Serial Clock			
SCL 2	SLAVE Serial Clock			
SDA 1	MASTER Serial Data			
SDA 2	SLAVE Serial Data			
Reset 1	Reset Input 1 (Active Low)			
Reset 2	Reset Input 2 (Active Low)			

BLOCK DIAGRAM



$\label{eq:maximum ratings} \textbf{MAXIMUM RATINGS} \ (V_{SS} \ \text{Reference})$

Rating	Symbol	Value	Unit
DC Supply Voltage	V _{DD}	-0.5 to +7.0	V
DC Input Voltage	V _{in}	–0.5 to V _{DD} + 0.5	V
DC Output Voltage	Vout	–0.5 to V _{DD} + 0.5	V
DC Input Output Current (per Pin)	I	25	mA
DC Supply Current (V _{DD} and GND Pin)	l _{dd}	75	mA
Storage Temperature	T _{stg}	-65 to +150	°C
Lead Temperature (1 mm from case for 10 sec)	ТL	300	°C

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Max	Unit
DC Supply Voltage	V _{DD}	4.0	6.0	V
DC Input Voltage	V _{in}	0.0	V _{DD}	V
Operating Temperature	TA	-40	+85	°C

$\textbf{DC CHARACTERISTICS} (V_{SS} \text{ Reference})$

		Guaranteed Limits		
Characteristic	Symbol	Min	Max	Unit
Input Voltage "H" Level	VIH	0.7 V _{DD}	-	V
Input Voltage "L" Level	VIL	-	0.3 V _{DD}	V
Output Voltage "L" Level I _{out} = 4 mA	VOL	-	0.3	V
Input Leakage Current Vin = VDD or VSS	lin	_	±1.0	μA
Tri–State Leakage Current Output = High Impedance; V _{out} = GND	I _{oz}	_	±5.0	μA
Offset Voltage (Reset 1, Reset 2)	VIO	-	±0.1	V
Input Pin Capacitance	C _{in}	-	10	pF
Output Pin Capacitance	Cout	-	15	pF
In/Out Pin Capacitance	C _{i/o}	_	15	pF
Quiescent Supply Current (per package)	I _{cc}	-	5.0	mA

APPLICATION BLOCK



I₂C BUS TRANSCEIVER SIGNALS



I₂C BUS TRANSCEIVER SIGNALS



I₂C BUS TRANSCEIVER SIGNALS (during RESET)

<<WRITE MODE>>



<<READ MODE>>

I₂C BUS TRANSCEIVER SIGNALS (during RESET)



BUS CONDITION KEY:

- S = START
- SA = SLAVE ACKNOWLEDGE
- MA = MASTER ACKNOWLEDGE
- P = STOP

		Guaranteed Limits		
Parameter	Symbol	Min	Max	Unit
SCL Clock Frequency	fCL	0	100	kHz
STOP Condition to START Condition Bus Free Time	^t BUF	4.7	-	μs
START Condition Hold Time	^t HD:STA	4.0	-	μs
SCL Clock LOW Hold Time	tLOW	4.7	-	μs
SCL Clock HI Hold Time	tHIGH	4.0	-	μs
SDA Data Hold Time	^t HD:DAT	0	-	μs
SDA Data Setup Time	^t SU:DAT	250	-	nS
SDA and SCL Signal Rise Time	^t R	-	1000	nS
SDA and SCL Signal Fall Time	tF	-	300	nS
STOP Condition Setup Time	tSU:STO	4.0	_	μs



SWITCHING CHART (V_{CC} = 5.0 V, t_R = 1000 nS, t_F = 300 nS)

		Nominal	Guaranteed Limits		
Parameter	Symbol	25°C	Min	Max	Unit
Maximum Delay SCL1 to SCL2	^t PHL:SCL	-	-	500	nS
Maximum Delay SCL1 to SCL2	^t PLZ:SCL	-	-	500	nS
Maximum Delay SDA1 to SDA2	^t PHL:SDA	-	-	500	nS
Maximum Delay SDA1 to SDA2	^t PLZ:SDA	-	-	500	nS
Maximum Delay SCL1 to SDA1,2 (Direction Change DATA = L)	^t PHL:SCL-SDA	_	_	500	nS
Maximum Delay SCL1 to SDA1,2 (Direction Change DATA = H)	^t PLZ:SCL-SDA	_	_	500	nS
Maximum Delay Reset to SDA1,2	^t PLZ:RES	-	-	500	nS
Maximum Output Fall Time SCL	^t THL:SCL	5.0	-	20	nS
Maximum Output Rise Time SDA	^t THL:SDA	5.0	-	20	nS
Maximum Group Delay tPHL:SCL-tPHL:SDA	^t PHL	1.0	_	10	nS
Maximum Group Delay tPLZ:SCLtPLZ:SDA	tpLZ	1.0	_	10	nS
Power On Reset Pulse Width	^t W:ROR	1500	-	-	nS

TIMING CONDITIONS (V_{DD} = 5.0 V)

		Nominal		Guaranteed Limits	
Parameter	Symbol	25°C	Min Max		Unit
Minimum Pulse Width Rese	t ^t W:RES	-	50	-	nS

(1) tPHL:SCL, tPLZ:SCL, tPHL:SDA, tPLZ:SDA, tTHL:SCL, tTHL:SDA



(2) tPHL:SCL-SDA, tPLZ:SCL-SDA





(4) tw:por, tw:res



TEST CIRCUIT



PACKAGE DIMENSIONS

SOEIAJ-8 **M SUFFIX** CASE 968-01 ISSUE O









PDIP-8 **P SUFFIX** CASE 626-05 ISSUE K



NOTES:

- DITES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER
 DIMENSION D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) DED SIDE
- PER SIDE. 4. TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY. 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTUSION. ALLOWABLE DAMBAR PROTRUSION. SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α		2.05		0.081
A1	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
С	0.18	0.27	0.007	0.011
D	5.10	5.50	0.201	0.217
E	5.10	5.45	0.201	0.215
е	1.27	BSC	0.050	BSC
HE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q1	0.70	0.90	0.028	0.035
Z		0.94		0.037

NOTES:

1. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.

2. PACKAGE CONTOUR OPTIONAL (ROUND OR SQUARE CORNERS)

3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

	MILLIMETERS		INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	9.40	10.16	0.370	0.400	
В	6.10	6.60	0.240	0.260	
С	3.94	4.45	0.155	0.175	
D	0.38	0.51	0.015	0.020	
F	1.02	1.78	0.040	0.070	
G	2.54	BSC	0.100 BSC		
Н	0.76	1.27	0.030	0.050	
J	0.20	0.30	0.008	0.012	
К	2.92	3.43	0.115	0.135	
L	7.62	BSC	0.300	BSC	
M		10°		10°	
N	0.76	1.01	0.030	0.040	

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